

Document History

Version	Release Date	Reason for issue
A	09/15/2006	Initial release
B	02/17/2009	Updated Product Identification information

Company


Company name: Rimage® Corporation

Company logo:







R I M A G E®

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 **Note:** This Waste from Electric and Electronic Equipment (WEEE) Recycling Passport provides information for treatment facilities. It is not a disassembly instruction. It is for Rimage marked products only. Original Equipment Manufacturer (OEM) products are identified where applicable. Contact the OEM for selective treatment information.


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Product Identification

Product name	Rimage DLN5100; Rimage DLN5200 Model: RAS14E; RAS15E			
Description	DLN5100	DL autoloader with 1 recorder; PC embedded. Ships with Prism printer.		
	DLN5200	DL autoloader with 2 recorders; PC embedded. Ships with Everest printer.		
WEEE Category	Category 3, IT & Telecommunication Equipment			
Product Weight	DLN5100	54 lbs (24.5 kg) without Prism printer		DLN5200
				53 lb (24.0 kg) without Everest printer
Product Dimensions	DLN5100			DLN5200
	Height	19.13 in (48.5 cm)		Height
	Width	14.5 in (36.8 cm)		Width
	Depth	23.5 in (59.1 cm)		Depth
Product Identification Note: Shown with attached printer. Refer to 112192 for Everest printer information. Refer to 112188 for Prism printer information.	DLN5100		DLN5200	
				
				

Product Structure

Location of Subassemblies

 **Note:** Places where the second number is the same for the DLN5200 images and the DLN5100 images indicates that the same component is used on both products.

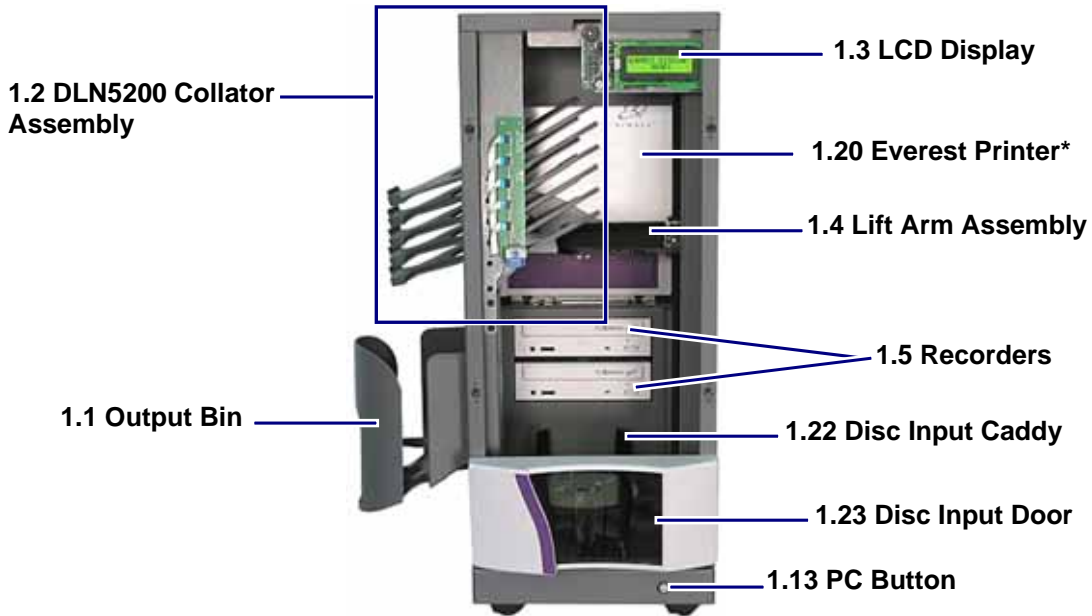


Fig. 1. DLN5200

*Refer to 112192 for Everest printer information.

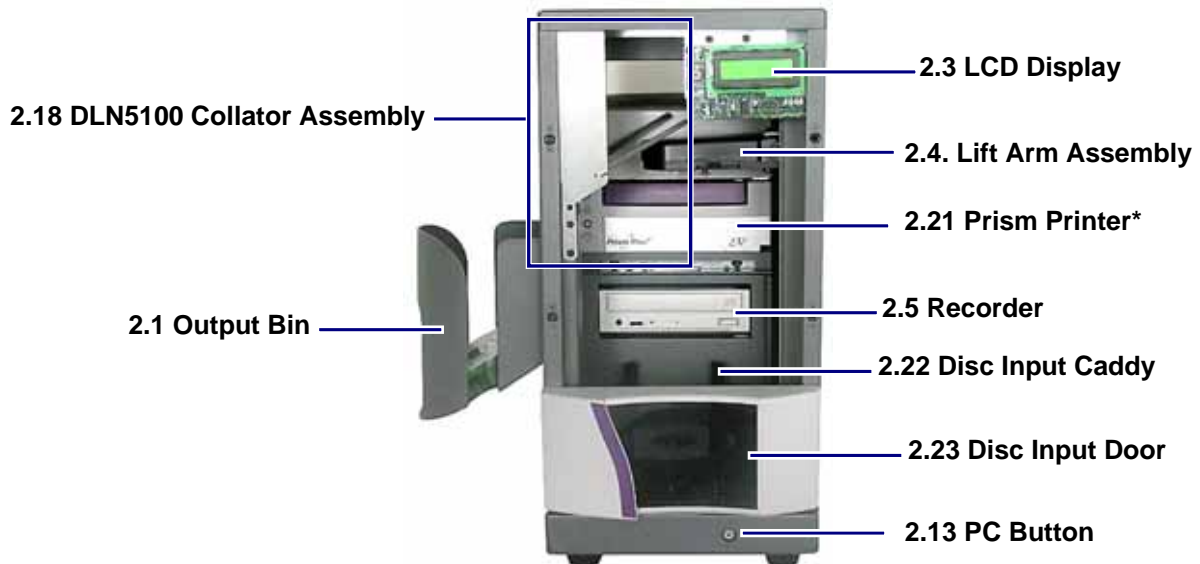


Fig. 2. DLN5100

*Refer to 112188 for Prsim printer information.



Fig. 3. DLN5200



Fig. 4. DLN5100 / DLN5200 Rear View

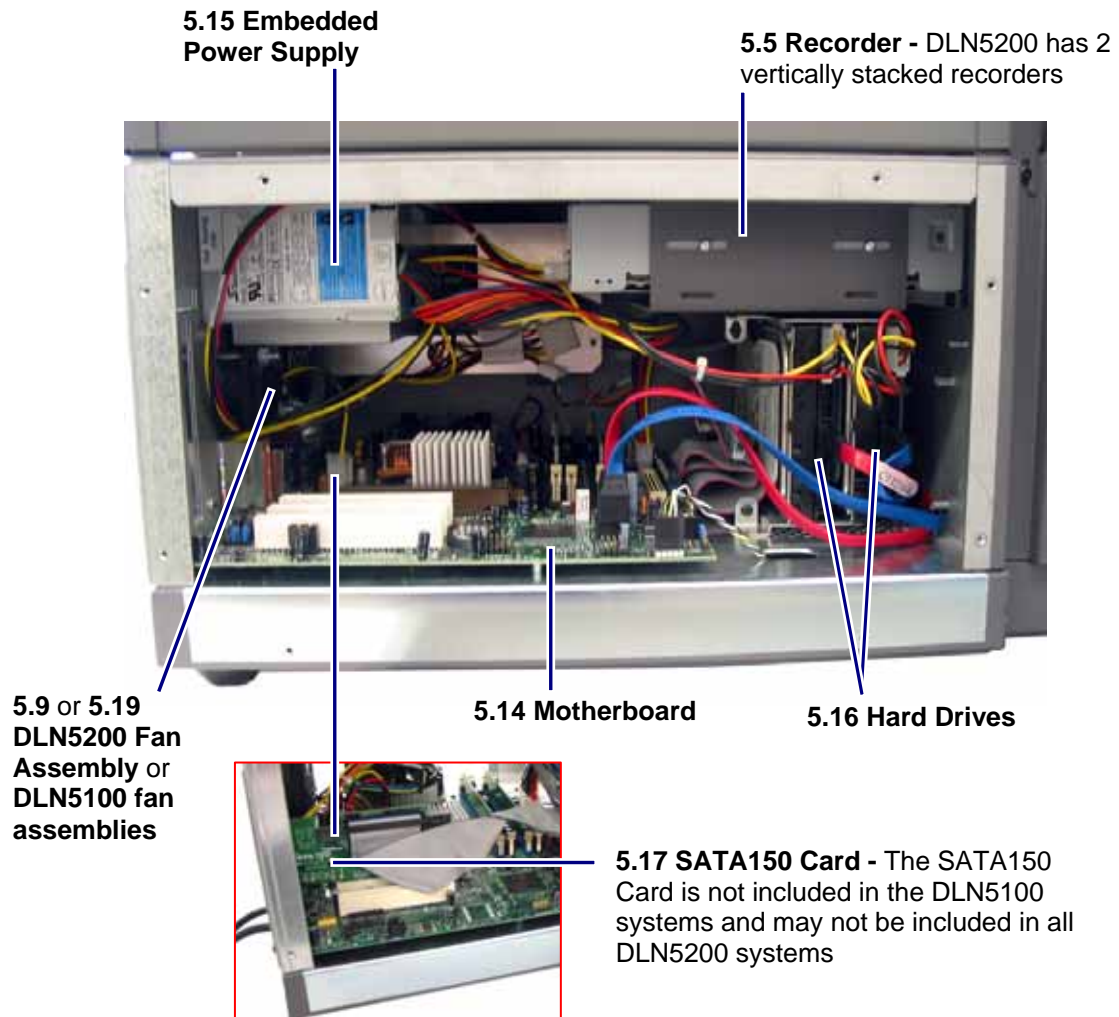


Fig. 5. DLN5100 / DLN5200 Left Side View

6.5 Recorder - DLN5200 has
2 vertically stacked recorders

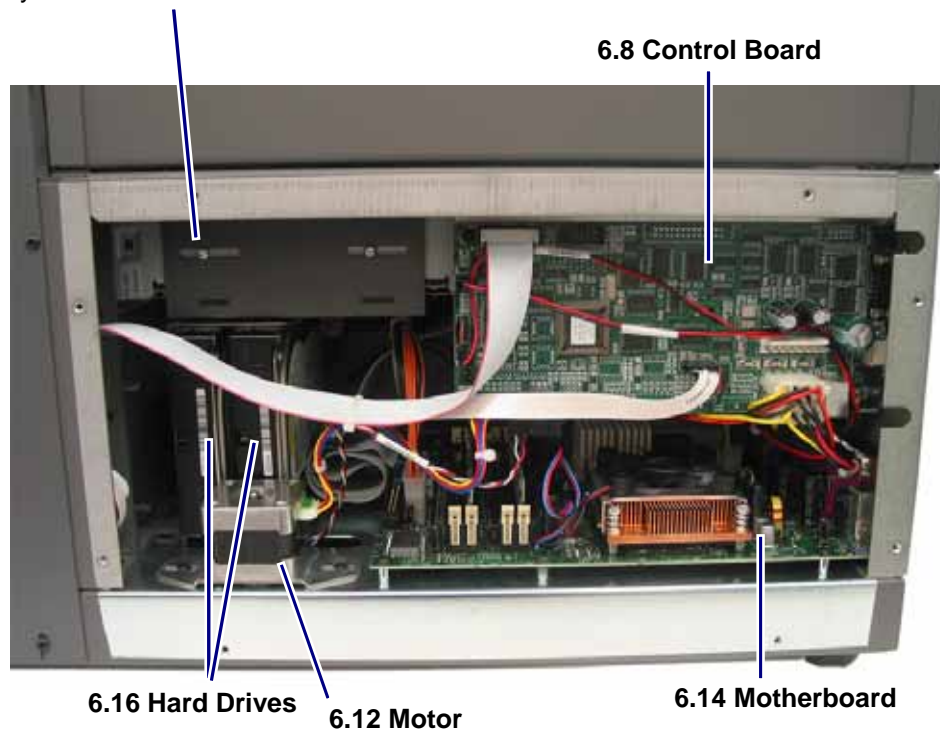


Fig. 6 DLN5100 / DLN5200 Right Side View

Subassembly Diagrams

Subassembly – #1



Door (see Product Identification Section)
Plastic may contain brominated flame retardants

Subassembly – #2



Item 1 – Output bin (see figures 1.1 and 2.1)
Plastic may contain brominated flame retardants

Subassembly – #3



Item 2 – Collator Tray (DLN5200 only) (see figure 1.2)
Plastic may contain brominated flame retardants

Subassembly – #4



Item 2 – Collator flap (see figures 1.2 and 2.2)
Plastic may contain brominated flame retardants

Subassembly – #5



Item 2 – Collator Board (DLN5200 only) (see figure 1.2)
Printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly – #6



Item 2 – Collator sensor board (DLN5200 only) (see figure 1.2)
Printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly – #7



Item 3 – LCD Display (see figures 1.3 and 2.3)

Printed circuit board; pre-RoHS board may contain lead

Subassembly – #8



Item 4 – Lift arm cover (see figures 1.4 and 2.4)

Plastic may contain brominated flame retardants

Subassembly – #9



Item 4 – Lift arm board (see figures 1.4 and 2.4)

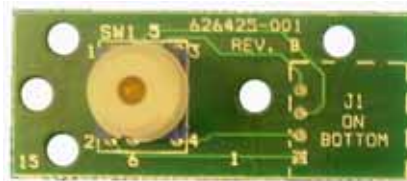
Printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly – #10



Item 5 – Recorder(s) (see figures 1.5, 2.5, 5.5, and 6.5)
OEM component; printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly – #11



Item 13 – PC Button (see figures 1.13 and 2.13)
Printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly – #12



Item 22 – Disc input caddy (see figures 1.22 and 2.22)
Plastic may contain brominated flame retardants

Subassembly – #13



Item 23 – Disc input door (see figures 1.23 and 2.23)

Plastic may contain brominated flame retardants

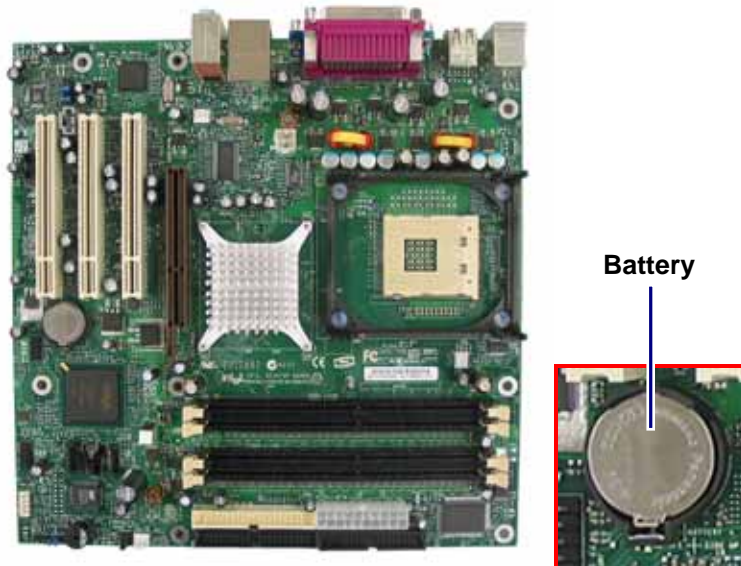
Subassembly - #14



Item 8 – Control board (see figures 3.8, 4.8, and 6.8)

Printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly - #15



Item 14 –Motherboard and battery on motherboard (see figures 3.14, 4.14, 5.14, and 6.14)

Printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly - #16



Item 15 –Embedded power supply (see figures 3.15, 4.15, 5.15, and 6.15)
OEM component; printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

Subassembly - #17



Item 16 –Hard drives (see figures 5.16 and 6.16)
OEM component; printed circuit board; pre-RoHS board may contain lead.
Boards marked with Pb-free symbol are RoHS compliant.

External cables – may be included



FireWire Cable



DIN Cable



Serial Cable



USB Cable



Power Cord

Reportable Materials

WEEE Annex II Reportable Materials

Material	Location
Polychlorinated biphenyl - containing capacitors	Absent
Mercury-containing components, such as switches or backlighting lamps	Absent
Batteries	Motherboard (Fig. 3.14; Fig. 4.14; Fig. 5.14; Fig. 6.14)
Printed circuit boards of mobile phones generally, and of other devices if the surface of the printed circuit board is greater than 10 square centimeters	<ul style="list-style-type: none"> • Collator board (Fig. 1.2) • Collator sensor board (Fig. 1.2) • LCD display (Fig 1.3; Fig. 2.3) • Lift arm control board (Fig. 1.4; Fig. 2.4) • Recorder (Fig. 1.5, Fig 2.5, Fig 5.5; Fig. 6.5) • PC button (Fig. 1.13; Fig. 2.13) • Control board (Fig. 3.8; Fig. 4.8; Fig. 6.8) • Motherboard (Fig. 3.14; Fig. 4.14; Fig. 5.14; Fig. 6.14) • Power supply (Fig. 3.15, Fig 4.15; Fig. 5.15; Fig. 6.15) • Hard drive (Fig. 5.16; Fig. 6.16)
Toner cartridges, liquid and pasty, as well as colour toner	Absent
Plastic containing brominated flame retardants	May be present: <ul style="list-style-type: none"> • Door (Product Identification) • Output bin (Fig. 1.1; Fig. 2.1) • Collator tray (Fig. 1.2) • Collator flap (Fig. 1.2; Fig. 2.2) • Lift arm cover (Fig. 1.4; Fig. 2.4) • Disc input caddy (Fig. 1.22; Fig. 2.22) • Disc input door (Fig. 1.23; Fig. 2.23)
Asbestos waste and components which contain asbestos	Absent
Cathode ray tubes	Absent
Chlorofluorocarbons (CFC), hydrochlorofluorocarbons (HCFC) or hydrofluorocarbons (HFC), hydrocarbons (HC)	Absent

WEEE Recycling Passport

Product: Rimage DLN5100; Rimage DLN5200

website: www.rimage.com

Material	Location
Gas discharge lamps	Absent
Liquid crystal displays (together with their casing where appropriate) of a surface greater than 100 square centimeters and all those back-lighted with gas discharge lamps	Absent
External electric cables	May be included – see product identification photos
Components containing radioactive substances, or materials that become radioactive as a result of the function of the product, such as ionising radiation	Absent
Electrolytic capacitors containing substances of concern (height > 25 mm, diameter > 25 mm or proportionately similar volume)	Absent
Equipment containing gases that are ozone-depleting or have a global warming potential (GWP) above 15, such as those contained in foams and refrigeration circuits.	Absent
Cadmium (Cd)	Absent
Hexavalent Chromium (Cr VI)	Absent
Lead (Pb)	Pre-RoHS = Yes, on all PCBs and cables Post-RoHS = No Boards marked with Pb-free symbol are RoHS compliant.
Mercury (Hg)	Absent
Polybrominated Biphenyls (PBB)	Absent
Polybrominated Diphenyl Ethers (PBDE)	Absent